

ISP1105/1106 Advanced USB transceivers Rev. 10 – 28 September 2009

**Product data sheet** 

### 1. General description

The ISP1105/1106 range of Universal Serial Bus (USB) transceivers are compliant with the *Universal Serial Bus Specification Rev. 2.0*. They can transmit and receive serial data at both full-speed (12 Mbit/s) and low-speed (1.5 Mbit/s) data rates. The ISP1105/1106 range can be used as a USB device transceiver or a USB host transceiver.

They allow USB Application Specific ICs (ASICs) and Programmable Logic Devices (PLDs) with power supply voltages from 1.65 V to 3.6 V to interface with the physical layer of the Universal Serial Bus. They have an integrated 5 V-to-3.3 V voltage regulator for direct powering via the USB supply  $V_{BUS}$ .

ISP1105 allows single-ended and differential input modes selectable by a MODE input and it is available in HVQFN16 and HBCC16 packages. ISP1106 allows only differential input mode and is available in both TSSOP16 and HBCC16 packages.

The ISP1105/1106 are ideal for portable electronics devices such as mobile phones, digital still cameras, Personal Digital Assistants (PDA) and Information Appliances (IA).

### 2. Features

- Complies with Universal Serial Bus Specification Rev. 2.0
- Can transmit and receive serial data at both full-speed (12 Mbit/s) and low-speed (1.5 Mbit/s) data rates
- Integrated bypassable 5 V-to-3.3 V voltage regulator for powering via USB V<sub>BUS</sub>
- V<sub>BUS</sub> disconnection indication through VP and VM
- Used as a USB device transceiver or a USB host transceiver
- Stable RCV output during SE0 condition
- Two single-ended receivers with hysteresis
- Low-power operation
- Supports an I/O voltage range from 1.65 V to 3.6 V
- ±12 kV ESD protection at the D+, D–, V<sub>CC(5.0)</sub> and GND pins
- Full industrial operating temperature range from -40 °C to +85 °C
- Available in small HBCC16, HVQFN16 (only ISP1105) and TSSOP16 (only ISP1106) packages

The ISP1105 HBCC16 and HVQFN16 are lead-free and halogen-free. The ISP1106 HBCC16 is lead-free.





## 3. Applications

- Portable electronic devices, such as:
  - Mobile phone
  - Digital still camera
  - Personal Digital Assistant (PDA)
  - Information Appliance (IA).

## 4. Ordering information

#### Table 1.Ordering information

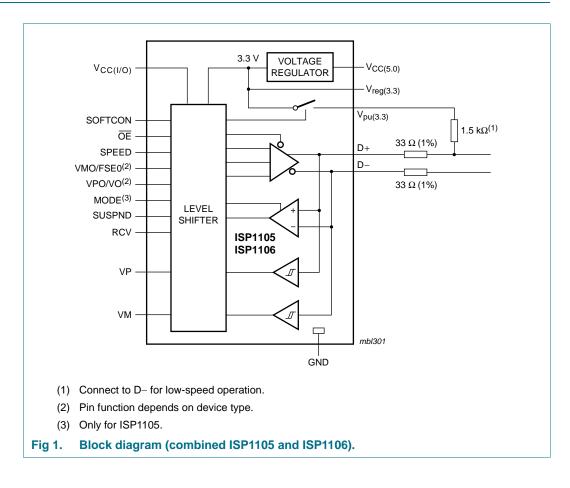
Commercial product code	Package description	Packing	Minimum sellable quantity
ISP1105BSTM	HVQFN16; 16 terminals; body $3 \times 3 \times 0.85$ mm	13 inch tape and reel non-dry pack	6000 pieces
ISP1105WTS	HBCC16; 16 terminals; body $3 \times 3 \times 0.65$ mm	7 inch tape and reel non-dry pack	1400 pieces
ISP1105WTM	HBCC16; 16 terminals; body $3 \times 3 \times 0.65$ mm	13 inch tape and reel non-dry pack	6000 pieces
ISP1106WTS	HBCC16; 16 terminals; body $3 \times 3 \times 0.65$ mm	7 inch tape and reel non-dry pack	1400 pieces
ISP1106DHTM	TSSOP16; 16 leads; body width 4.4 mm	13 inch tape and reel non-dry pack	2500 pieces

### 4.1 Ordering options

Table 2.	Selection guide	
Product	Package	Description
ISP1105	HVQFN16 and HBCC16	supports both single-ended and differential input modes; see <u>Table 5</u> and <u>Table 6</u> .
ISP1106	TSSOP16 and HBCC16	supports only the differential input mode; see <u>Table 6</u> .

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## 5. Block diagram

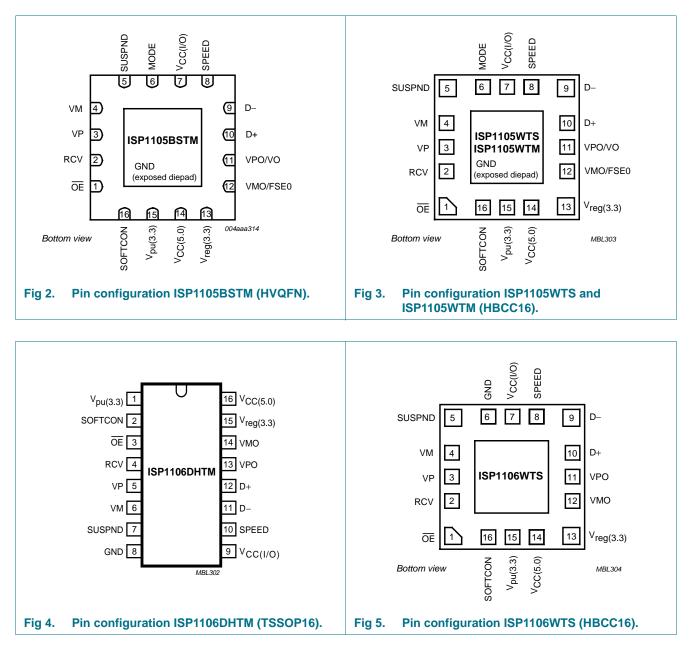




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## 6. Pinning information

### 6.1 Pinning



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### 6.2 Pin description

Table 3.	Pin desci	in description						
Symbol <sup>[1]</sup>	Pin	Pin			Туре	Description		
	ISP11	05	ISP110	6				
	BSTM	WTS, WTM	DHTM	WTS				
ŌĒ	1	1	3	1	I	output enable input (CMOS level with respect to $V_{CC(I/O)}$ , active LOW); enables the transceiver to transmit data on the USB bus input pad; push pull; CMOS		
RCV	2	2	4	2	0	differential data receiver output (CMOS level with respect to $V_{CC(I/O)}$ ); driven LOW when input SUSPND is HIGH; the output state of RCV is preserved and stable during an SE0 condition		
						output pad; push pull; 4 mA output drive; CMOS		
VP	3	3	5	3	0	single-ended D+ receiver output (CMOS level with respect to $V_{CC(I/O)}$ ); for external detection of single-ended zero (SE0), error conditions, speed of connected device; driven HIGH when no supply voltage is connected to $V_{CC(5.0)}$ and $V_{reg(3.3)}$ output pad; push pull; 4 mA output drive; CMOS		
VM	4	4	6	4	0	single-ended D- receiver output (CMOS level with respect to $V_{CC(I/O)}$ );		
V IVI	-	-	0	-	U	for external detection of single-ended zero (SE0), error conditions, speed of connected device; driven HIGH when no supply voltage is connected to $V_{CC(5.0)}$ and $V_{reg(3.3)}$		
						output pad; push pull; 4 mA output drive; CMOS		
SUSPND	5	5	7	5	I	suspend input (CMOS level with respect to $V_{CC(I/O)}$ ); a HIGH level enables low-power state while the USB bus is inactive and drives output RCV to a LOW level		
						input pad; push pull; CMOS		
MODE	6	6	-	-	I	mode input (CMOS level with respect to $V_{CC(l/O)}$ ); a HIGH level enables the differential input mode (VPO, VMO) whereas a LOW level enables a single-ended input mode (VO, FSE0); see <u>Table 5</u> and <u>Table 6</u>		
						input pad; push pull; CMOS		
GND	die pad	die pad	8	6	-	ground supply <sup>[2]</sup>		
V <sub>CC(I/O)</sub>	7	7	9	7	-	supply voltage for digital I/O pins (1.65 V to 3.6 V). When V <sub>CC(I/O)</sub> is not connected, the (D+, D–) pins are in three-state; this supply pin is totally independent of V <sub>CC(5.0)</sub> and V <sub>reg(3.3)</sub> and must never exceed the V <sub>reg(3.3)</sub> voltage		
SPEED	8	8	10	8	I	speed selection input (CMOS level with respect to $V_{CC(I/O)}$ ); adjusts the slew rate of differential data outputs D+ and D– according to the transmission speed <b>LOW</b> — low-speed (1.5 Mbit/s)		
						HIGH — full-speed (12 Mbit/s)		
						input pad; push pull; CMOS		
D-	9	9	11	9	AI/O	negative USB data bus connection (analog, differential); for low-speed mode connect to pin $V_{pu(3.3)}$ via a 1.5 k $\Omega$ resistor		
D+	10	10	12	10	AI/O	positive USB data bus connection (analog, differential); for full-speed mode connect to pin $V_{pu(3.3)}$ via a 1.5 k $\Omega$ resistor		

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Symbol <sup>[1]</sup>	Pin				Туре	Description
	ISP110	5	ISP110	6		
	BSTM	WTS, WTM	DHTM	WTS		
VPO/VO	11	11	-	-	I	driver data input (CMOS level with respect to $V_{CC(I/O)}$ , Schmitt trigger);
VPO	-	-	13	11		see <u>Table 5</u> and <u>Table 6</u>
VO	-	-	-	-		input pad; push pull; CMOS
VMO/FSE0	12	12	-	-	I	driver data input (CMOS level with respect to $V_{CC(I/O)}$ , Schmitt trigger);
VMO	-	-	14	12		see Table 5 and Table 6
FSE0	-	-	-	-		input pad; push pull; CMOS
V <sub>reg(3.3)</sub>	13	13	15	13	-	internal regulator option: regulated supply voltage output (3.0 V to 3.6 V) during 5 V operation; a decoupling capacitor of at least 0.1 $\mu$ F is required regulator bypass option: used as a supply voltage input for 3.3 V $\pm$ 10 % operation
V <sub>CC(5.0)</sub>	14	14	16	14	-	internal regulator option: supply voltage input (4.0 V to 5.5 V); can be connected directly to USB supply $V_{\text{BUS}}$
						regulator bypass option: connect to V <sub>reg(3.3)</sub>
V <sub>pu(3.3)</sub>	15	15	1	15	-	pull-up supply voltage (3.3 V $\pm$ 10 %); connect an external 1.5 k $\Omega$ resistor on D+ (full-speed) or D– (low-speed); pin function is controlled by input SOFTCON
						$\textbf{SOFTCON} = \textbf{LOW} - V_{pu(3.3)}$ floating (high impedance); ensures zero pull-up current
						<b>SOFTCON = HIGH</b> — $V_{pu(3.3)}$ = 3.3 V; internally connected to $V_{reg(3.3)}$
SOFTCON	16	16	2	16	I	software controlled USB connection input; a HIGH level applies 3.3 V to pin V <sub>pu(3.3)</sub> , which is connected to an external 1.5 k $\Omega$ pull-up resistor; this allows USB connect/disconnect signalling to be controlled by software
						input pad; push pull; CMOS

#### Table 3. Pin description ...continued

[1] Symbol names with an overscore (e.g. NAME) indicate active LOW signals.

[2] ISP1105: ground terminal is connected to the exposed die pad (heat sink).



### 7. Functional description

#### 7.1 Function selection

#### Table 4. Function table

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SUSPND	OE	(D+, D–)	RCV	VP/VM	Function
L	L	driving and receiving	active	active	normal driving (differential receiver active)
L	Н	receiving <sup>[1]</sup>	active	active	receiving
Η	L	driving	inactive <sup>[2]</sup>	active	driving during 'suspend' <u>(</u> (differential receiver inactive)
Н	Н	high-Z <sup>[1]</sup>	inactive <sup>[2]</sup>	active	low-power state

[1] Signal levels on (D+, D–) are determined by other USB devices and external pull-up/down resistors.

[2] In 'suspend' mode (SUSPND = HIGH) the differential receiver is inactive and output RCV is always LOW. Out-of-suspend ('K') signalling is detected via the single-ended receivers VP and VM.

[3] During suspend, the slew-rate control circuit of low-speed operation is disabled. The (D+, D–) lines are still driven to their intended states, without slew-rate control. This is permitted because driving during suspend is used to signal remote wake-up by driving a 'K' signal (one transition from idle to 'K' state) for a period of 1 to 15 ms.

### 7.2 Operating functions

Table 5.	Driving function (pin $\overline{OE}$ = L) using single-ended input data interface for ISP1105
	(pin MODE = L)

FSE0	VO	Data
L	L	differential logic 0
L	Н	differential logic 1
Н	L	SE0
Н	Н	SE0

# Table 6.Driving function (pin $\overline{OE} = L$ ) using differential input data interface for ISP1105<br/>(pin MODE = H) and ISP1106

VMO	VPO	Data
L	L	SE0
L	Н	differential logic 1
Н	L	differential logic 0
Н	Н	illegal state

#### Table 7. Receiving function (pin $\overline{OE} = H$ )

(D+, D–)	RCV	VP <sup>[1]</sup>	VM[1]
Differential logic 0	L	L	Н
Differential logic 1	Н	Н	L
SE0	RCV*[2]	L	L

[1] VP = VM = H indicates the sharing mode ( $V_{CC(5.0)}$  and  $V_{reg(3.3)}$  are disconnected).

[2] RCV\* denotes the signal level on output RCV just before SE0 state occurs. This level is stable during the SE0 period.

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### 7.3 Power supply configurations

The ISP1105/1106 can be used with different power supply configurations, which can be changed dynamically. An overview is given in <u>Table 9</u>.

**Normal mode** — Both V<sub>CC(I/O)</sub> and V<sub>CC(5.0)</sub> or (V<sub>CC(5.0)</sub> and V<sub>reg(3.3)</sub>) are connected. For 5 V operation, V<sub>CC(5.0)</sub> is connected to a 5 V source (4.0 V to 5.5 V). The internal voltage regulator then produces 3.3 V for the USB connections. For 3.3 V operation, both V<sub>CC(5.0)</sub> and V<sub>reg(3.3)</sub> are connected to a 3.3 V source (3.0 V to 3.6 V). V<sub>CC(I/O)</sub> is independently connected to a voltage source (1.65 V to 3.6 V), depending on the supply voltage of the external circuit.

**Disable mode** —  $V_{CC(I/O)}$  is not connected,  $V_{CC(5.0)}$  or ( $V_{CC(5.0)}$  and  $V_{reg(3.3)}$ ) are connected. In this mode, the internal circuits of the ISP1105/1106 ensure that the (D+, D–) pins are in three-state and the power consumption drops to the low-power (suspended) state level. Some hysteresis is built into the detection of  $V_{CC(I/O)}$  lost.

**Sharing mode** — V<sub>CC(I/O)</sub> is connected, (V<sub>CC(5.0)</sub> and V<sub>reg(3.3)</sub>) are not connected. In this mode, the (D+, D–) pins are made three-state and the ISP1105/1106 allows external signals of up to 3.6 V to share the (D+, D–) lines. The internal circuits of the ISP1105/1106 ensure that virtually no current (maximum 10  $\mu$ A) is drawn via the (D+, D–) lines. The power consumption through pin V<sub>CC(I/O)</sub> drops to the low-power (suspended) state level. Both the VP and VM pins are driven HIGH to indicate this mode. Pin RCV is made LOW. Some hysteresis is built into the detection of V<sub>req(3.3)</sub> lost.

#### Table 8. Pin states in disable or sharing mode

Pins	Disable mode state	Sharing mode state
V <sub>CC(5.0)</sub> / V <sub>reg(3.3)</sub>	5 V input / 3.3 V output; 3.3 V input / 3.3 V input	not present
V <sub>CC(I/O)</sub>	not present	1.65 V to 3.6 V input
V <sub>pu(3.3)</sub>	high impedance (off)	high impedance (off)
(D+, D–)	high impedance	high impedance
(VP, VM)	invalid <sup>[1]</sup>	Н
RCV	invalid <sup>[1]</sup>	L
Inputs (VO/VPO, FSE0/VMO, SPEED, MODE <sup>[2]</sup> , SUSPND, OE, SOFTCON)	high impedance	high impedance

[1] High impedance or driven LOW.

[2] ISP1105 only.

#### Table 9. Power supply configuration overview

$V_{CC(5.0)}$ or $V_{reg(3.3)}$	V <sub>CC(I/O)</sub>	Configuration	Special characteristics
Connected	connected	normal mode	-
Connected	not connected	disable mode	(D+, D–) and V <sub>pu(3.3)</sub> high impedance; VP, VM, RCV: invalid <sup>[1]</sup>
Not connected	connected	sharing mode	(D+, D–) and V <sub>pu(3.3)</sub> high impedance; VP, VM driven HIGH; RCV driven LOW

[1] High impedance or driven LOW.

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### 7.4 Power supply input options

The ISP1105/1106 range has two power supply input options.

**Internal regulator** — V<sub>CC(5.0)</sub> is connected to 4.0 V to 5.5 V. The internal regulator is used to supply the internal circuitry with 3.3 V (nominal). The V<sub>reg(3.3)</sub> pin becomes a 3.3 V output reference.

**Regulator bypass** —  $V_{CC(5.0)}$  and  $V_{reg(3.3)}$  are connected to the same supply. The internal regulator is bypassed and the internal circuitry is supplied directly from the  $V_{reg(3.3)}$  power supply. The voltage range is 3.0 V to 3.6 V to comply with the USB specification.

The supply voltage range for each input option is specified in <u>Table 10</u>.

#### Table 10. Power supply input options

Input option	V <sub>CC(5.0)</sub>	V <sub>reg(3.3)</sub>	V <sub>CC(I/O)</sub>
Internal regulator	supply input for internal regulator (4.0 V to 5.5 V)	voltage reference output (3.3 V, 300 μA)	supply input for digital I/O pins (1.65 V to 3.6 V)
Regulator bypass	connected to $V_{reg(3.3)}$ with maximum voltage drop of 0.3 V (2.7 V to 3.6 V)	supply input (3.0 V to 3.6 V)	supply input for digital I/O pins (1.65 V to 3.6 V)

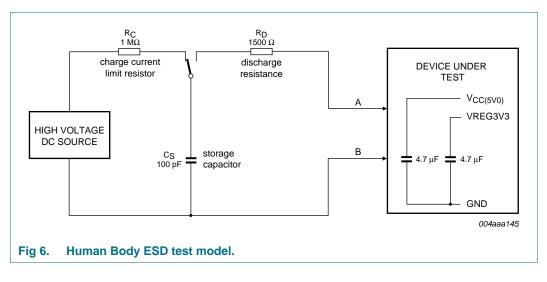


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## 8. Electrostatic discharge (ESD)

### 8.1 ESD protection

The pins that are connected to the USB connector (D+, D–, V<sub>CC(5.0)</sub> and GND) have a minimum of ±12 kV ESD protection. The ±12 kV measurement is limited by the test equipment. Capacitors of 4.7  $\mu$ F connected from V<sub>reg(3.3)</sub> to GND and V<sub>CC(5.0)</sub> to GND are required to achieve this ±12 kV ESD protection (see Figure 6).



#### 8.2 ESD test conditions

A detailed report on test set-up and results is available on request.

### 9. Limiting values

#### Table 11. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

0	Denementar	O an all the ma	N#!	Mara	11
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC(5.0)</sub>	supply voltage		-0.5	+6.0	V
V <sub>CC(I/O)</sub>	I/O supply voltage		-0.5	+4.6	V
V <sub>reg(3.3)</sub>	regulated supply voltage		-0.5	+4.6	V
VI	DC input voltage		-0.5	$V_{CC(I/O)} + 0.5$	V
l <sub>lu</sub>	latch-up current	$V_{I} = -1.8 \text{ V to } 5.4 \text{ V}$	-	100	mA
V <sub>esd</sub>	electrostatic discharge voltage	I <sub>LI</sub> < 1 μΑ	[1][2]		
		on pins D+, D–, $V_{CC(5.0)}$ and GND	-12000	+12000	V
		on other pins	-2000	+2000	V
T <sub>stg</sub>	storage temperature		-40	+125	°C

[1] Testing equipment limits measurement to only  $\pm$ 12 kV. Capacitors needed on V<sub>CC(5.0)</sub> and V<sub>reg(3.3)</sub>; see Section 8.

[2] Equivalent to discharging a 100 pF capacitor via a 1.5 k $\Omega$  resistor (Human Body Model).

## **10.** Recommended operating conditions

#### Table 12. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>CC(5.0)</sub>	supply voltage (internal regulator option)	5 V operation	4.0	5.0	5.5	V
V <sub>reg(3.3)</sub>	supply voltage (regulator bypass option)	3.3 V operation	3.0	3.3	3.6	V
V <sub>CC(I/O)</sub>	I/O supply voltage		1.65	-	3.6	V
VI	input voltage		0	-	V <sub>CC(I/O)</sub>	V
V <sub>I(AI/O)</sub>	input voltage on analog I/O pins (D+/D–)		0	-	3.6	V
T <sub>amb</sub>	operating ambient temperatur	e	-40	-	+85	°C



## **11. Static characteristics**

#### Table 13. Static characteristics: supply pins

 $V_{CC} = 4.0 \text{ V}$  to 5.5 V or  $V_{reg(3.3)} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $V_{GND} = 0 \text{ V}$ ; see <u>Table 10</u> for valid voltage level combinations;  $T_{amb} = -40 \text{ °C}$  to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V <sub>reg(3.3)</sub>	regulated supply voltage output	internal regulator option; $I_{load} \leq 300 \ \mu A$	<u>[1][2]</u>	3.0	3.3	3.6	V
I <sub>CC</sub>	operating supply current	full-speed transmitting and receiving at 12 Mbit/s; $C_L = 50 \text{ pF}$ on D+/D–	<u>[3]</u>	-	4	8	mA
I <sub>CC(I/O)</sub>	operating I/O supply current	full-speed transmitting and receiving at 12 Mbit/s	[3]	-	1	2	mA
I <sub>CC(idle)</sub>	supply current during full-speed idle and SE0	full-speed idle: V_{D+} > 2.7 V, V_{D-} < 0.3 V; SE0: V_{D+} < 0.3 V, V_{D-} < 0.3 V	<u>[4]</u>	-	-	500	μΑ
I <sub>CC(I/O)(static)</sub>	static I/O supply current	full-speed idle, SE0 or suspend		-	-	20	μA
I <sub>CC(susp)</sub>	suspend supply current	SUSPND = HIGH	[4]	-	-	20	μA
I <sub>CC(dis)</sub>	disable mode supply current	V <sub>CC(I/O)</sub> not connected	[4]	-	-	20	μA
I <sub>CC(I/O)(sharing)</sub>	sharing mode I/O supply current	$V_{CC(5.0)} \text{ or } V_{reg(3.3)} \text{ not connected}$		-	-	20	μA
I <sub>Dx(sharing)</sub>	sharing mode load current on pins D+ and D–	$V_{CC(5.0)}$ or $V_{reg(3.3)}$ not connected; SOFTCON = LOW; $V_{Dx}$ = 3.6 V		-	-	10	μA
V <sub>reg(3.3)th</sub>	regulated supply voltage detection threshold	$ \begin{array}{l} 1.65 \ V \leq V_{CC(I/O)} \leq V_{reg(3.3)}; \\ 2.7 \ V \leq V_{reg(3.3)} \leq 3.6 \ V \end{array} $					
		supply lost		-	-	0.8	V
		supply present	[5]	2.4	-	-	V
V <sub>reg(3.3)hys</sub>	regulated supply voltage detection hysteresis	$V_{CC(I/O)} = 1.8 V$		-	0.45	-	V
V <sub>CC(I/O)th</sub>	I/O supply voltage detection	V <sub>reg(3.3)</sub> = 2.7 V to 3.6 V					
	threshold	supply lost		-	-	0.5	V
		supply present		1.4	-	-	V
V <sub>CC(I/O)hys</sub>	I/O supply voltage detection hysteresis	V <sub>reg(3.3)</sub> = 3.3 V		-	0.45	-	V

[1]  $I_{load}$  includes the pull-up resistor current via pin  $V_{pu(3.3)}$ .

[2] In 'suspend' mode, the minimum voltage is 2.7 V.

[3] Maximum value is characterized only, not tested in production.

[5] When  $V_{CC(I/O)}$  < 2.7 V, the minimum value for  $V_{th(reg3.3)(present)}$  is 2.0 V.

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V <sub>CC(I/O)</sub> = 1.65 Input levels V <sub>IL</sub> V <sub>IH</sub> Output levels V <sub>OL</sub>	LOW-level input voltage HIGH-level input voltage LOW-level output voltage	l <sub>OL</sub> = 100 μA	- 0.6V <sub>CC(I/O)</sub>	-	0.3V <sub>CC(I/O)</sub>	V
V <sub>IL</sub> V <sub>IH</sub> Output levels V <sub>OL</sub>	HIGH-level input voltage		- 0.6V <sub>CC(I/O)</sub>	-	0.3V <sub>CC(I/O)</sub>	V
V <sub>IH</sub> Output levels V <sub>OL</sub>	HIGH-level input voltage		- 0.6V <sub>CC(I/O)</sub>	-	0.3V <sub>CC(I/O)</sub>	V
Output levels V <sub>OL</sub>	LOW-level output voltage		0.6V <sub>CC(I/O)</sub>	-	-	
V <sub>OL</sub>						V
V <sub>OH</sub>	HIGH-level output voltage		-	-	0.15	V
V <sub>ОН</sub>	HIGH-level output voltage	I <sub>OL</sub> = 2 mA	-	-	0.4	V
		I <sub>OH</sub> = 100 μA	$V_{CC(I/O)} - 0.15$	-	-	V
		I <sub>OH</sub> = 2 mA	$V_{CC(I/O)} - 0.4$	-	-	V
Leakage curre	ent					
ILI	input leakage current		-1	-	+1	μA
Example 1: V	$ m C_{CC(I/O)}$ = 1.8 V $\pm$ 0.15 V					
Input levels						
V <sub>IL</sub>	LOW-level input voltage		-	-	0.5	V
VIH	HIGH-level input voltage		1.2	-	-	V
Output levels						
V <sub>OL</sub>	LOW-level output voltage	I <sub>OL</sub> = 100 μA	-	-	0.15	V
		$I_{OL} = 2 \text{ mA}$	-	-	0.4	V
V <sub>OH</sub>	HIGH-level output voltage	I <sub>OH</sub> = 100 μA	1.5	-	-	V
		I <sub>OH</sub> = 2 mA	1.25	-	-	V
Example 2: V	$C_{CC(I/O)} = 2.5 \text{ V} \pm 0.2 \text{ V}$					
Input levels						
V <sub>IL</sub>	LOW-level input voltage		-	-	0.7	V
V <sub>IH</sub>	HIGH-level input voltage		1.7	-	-	V
Output levels						
V <sub>OL</sub>	LOW-level output voltage	I <sub>OL</sub> = 100 μA	-	-	0.15	V
		$I_{OL} = 2 \text{ mA}$	-	-	0.4	V
V <sub>OH</sub>	HIGH-level output voltage	I <sub>OH</sub> = 100 μA	2.15	-	-	V
		I <sub>OH</sub> = 2 mA	1.9	-	-	V
Example 3: V	/ <sub>CC(I/O)</sub> = 3.3 V ± 0.3 V					
Input levels						
V <sub>IL</sub>	LOW-level input voltage		-	-	0.9	V
V <sub>IH</sub>	HIGH-level input voltage		2.15	-	-	V
Output levels						
V <sub>OL</sub>	LOW-level output voltage	I <sub>OL</sub> = 100 μA	-	-	0.15	V
		$I_{OL} = 2 \text{ mA}$	-	-	0.4	V
V <sub>OH</sub>	HIGH-level output voltage	I <sub>OH</sub> = 100 μA	2.85	-	-	V
	. 0	$I_{OH} = 2 \text{ mA}$	2.6	-	-	V
Capacitance						
C <sub>IN</sub>	input capacitance	pin to GND	-	-	10	pF

#### Table 14. Static characteristics: digital pins

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Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Input levels	S						
Differential	receiver						
V <sub>DI</sub>	differential input sensitivity	$ V_{I(D+)}-V_{I(D-)} $		0.2	-	-	V
V <sub>CM</sub>	differential common mode voltage	includes V <sub>DI</sub> range		0.8	-	2.5	V
Single-ende	ed receiver						
VIL	LOW-level input voltage			-	-	0.8	V
V <sub>IH</sub>	HIGH-level input voltage			2.0	-	-	V
V <sub>hys</sub>	hysteresis voltage			0.4	-	0.7	V
Output lev	els						
V <sub>OL</sub>	LOW-level output voltage	$R_L$ = 1.5 k $\Omega$ to +3.6 V		-	-	0.3	V
V <sub>OH</sub>	HIGH-level output voltage	$R_L = 15 \text{ k}\Omega \text{ to GND}$	<u>[1]</u>	2.8	-	3.6	V
Leakage cu	urrent						
I <sub>LZ</sub>	OFF-state leakage current			-1	-	+1	μΑ
Capacitanc	ce						
C <sub>IN</sub>	transceiver capacitance	pin to GND		-	-	20	pF
Resistance	)						
Z <sub>DRV</sub>	driver output impedance	steady-state drive	[2]	34	39	44	Ω
Z <sub>INP</sub>	input impedance			10	-	-	MΩ
R <sub>SW</sub>	internal switch resistance at pin $V_{\text{pu(3.3)}}$			-	-	10	Ω
Terminatio	n						
V <sub>TERM</sub>	termination voltage for upstream port pull-up (R <sub>PU</sub> )		<u>[3][4]</u>	3.0	-	3.6	V

## **Table 15.** Static characteristics: analog I/O pins (D+, D-) $V_{CC} = 4.0 \text{ V to } 5.5 \text{ V or } V_{COC} = 3.0 \text{ V to } 3.6 \text{ V; } V_{CND} = 0 \text{ V; } T_{C}$

10 °C to 185 °C rwise ocified th

[1]  $V_{OH(min)} = V_{reg(3.3)} - 0.2 V.$ 

Includes external resistors of 33  $\Omega\pm$  1 % on both D+ and D–. [2]

[3] This voltage is available at pins  $V_{\text{reg}(3.3)}$  and  $V_{\text{pu}(3.3)}.$ 

In 'suspend' mode the minimum voltage is 2.7 V. [4]

## **12. Dynamic characteristics**

#### Table 16. Dynamic characteristics: analog I/O pins (D+, D–)

 $V_{CC} = 4.0 \text{ V}$  to 5.5 V or  $V_{reg(3.3)} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(I/O)} = 1.65 \text{ V}$  to 3.6 V;  $V_{GND} = 0 \text{ V}$ ; see <u>Table 10</u> for valid voltage level combinations;  $T_{amb} = -40 \text{ °C}$  to +85 °C; unless otherwise specified.<sup>[1]</sup>

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Driver cha	racteristics						
Full-speed	mode						
t <sub>FR</sub>	rise time	$C_L$ = 50 pF to 125 pF; 10 % to 90 % of $ V_{OH}-V_{OL} ;$ see Figure 7		4	-	20	ns
t <sub>FF</sub>	fall time	$C_L$ = 50 pF to 125 pF; 90 % to 10 % of $ V_{OH}-V_{OL} ;$ see $\underline{Figure\ 7}$		4	-	20	ns
FRFM	differential rise/fall time matching (t <sub>FR</sub> /t <sub>FF</sub> )	excluding the first transition from idle state		90	-	111.1	%
V <sub>CRS</sub>	output signal crossover voltage	excluding the first transition from idle state; see Figure 10	[2]	1.3	-	2.0	V
Low-speed	mode						
t <sub>LR</sub>	rise time	$C_L$ = 50 pF to 600 pF; 10 % to 90 % of $ V_{OH}-V_{OL} ;$ see Figure 7		75	-	300	ns
t <sub>LF</sub>	fall time	$C_L$ = 50 pF to 600 pF; 90 % to 10 % of $ V_{OH}-V_{OL} ;$ see <u>Figure 7</u>		75	-	300	ns
LRFM	differential rise/fall time matching (t <sub>LR</sub> /t <sub>LF</sub> )	excluding the first transition from idle state		80	-	125	%
V <sub>CRS</sub>	output signal crossover voltage	excluding the first transition from idle state; see Figure 10	[2]	1.3	-	2.0	V
Driver timi	ng						
Full-speed	mode						
t <sub>PLH(drv)</sub>	driver propagation delay (VO/VPO, FSE0/VMO to D+,D-)	LOW-to-HIGH; see Figure 10		-	-	18	ns
t <sub>PHL(drv)</sub>	driver propagation delay (VO/VPO, FSE0/VMO to D+,D-)	HIGH-to-LOW; see Figure 10		-	-	18	ns
t <sub>PHZ</sub>	driver disable delay ( $\overline{OE}$ to D+,D–)	HIGH-to-OFF; see Figure 8		-	-	15	ns
t <sub>PLZ</sub>	driver disable delay ( $\overline{OE}$ to D+,D–)	LOW-to-OFF; see Figure 8		-	-	15	ns
<sup>I</sup> PZH	driver enable delay ( $\overline{OE}$ to D+,D–)	OFF-to-HIGH; see Figure 8		-	-	15	ns
PZL	driver enable delay (OE	OFF-to-LOW; see Figure 8		-	-	15	ns

#### Low-speed mode

Not specified: low-speed delay timings are dominated by the slow rise/fall times tLR and tLF.

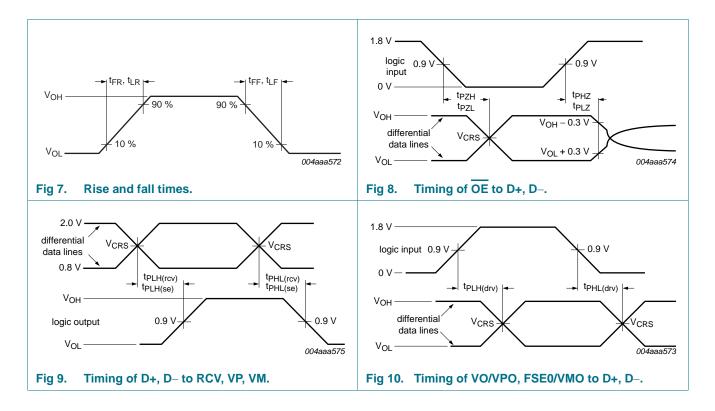
#### Table 16. Dynamic characteristics: analog I/O pins (D+, D-) ... continued

 $V_{CC} = 4.0 \text{ V}$  to 5.5 V or  $V_{reg(3.3)} = 3.0 \text{ V}$  to 3.6 V;  $V_{CC(1/O)} = 1.65 \text{ V}$  to 3.6 V;  $V_{GND} = 0 \text{ V}$ ; see <u>Table 10</u> for valid voltage level combinations;  $T_{amb} = -40 \text{ °C}$  to +85 °C; unless otherwise specified.[1]

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Receiver	timings (full-speed and	low-speed mode)				
Differentia	l receiver					
t <sub>PLH(rcv)</sub>	propagation delay (D+,D– to RCV)	LOW-to-HIGH; see Figure 9	-	-	15	ns
t <sub>PHL(rcv)</sub>	propagation delay (D+,D– to RCV)	HIGH-to-LOW; see Figure 9	-	-	15	ns
Single-end	led receiver					
t <sub>PLH(se)</sub>	propagation delay (D+,D– to VP, VM)	LOW-to-HIGH; see Figure 9	-	-	18	ns
t <sub>PHL(se)</sub>	propagation delay (D+,D– to VP, VM)	HIGH-to-LOW; see <u>Figure 9</u>	-	-	18	ns

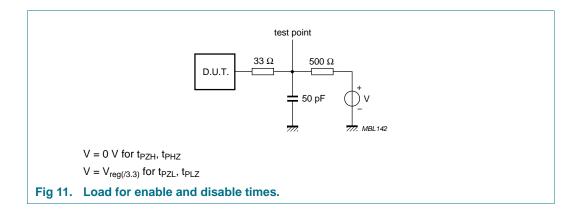
[1] Test circuit: see Figure 13.

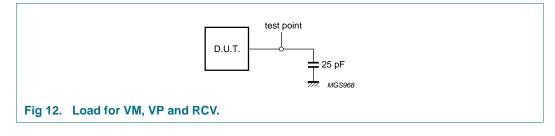
[2] Characterized only, not tested. Limits guaranteed by design.

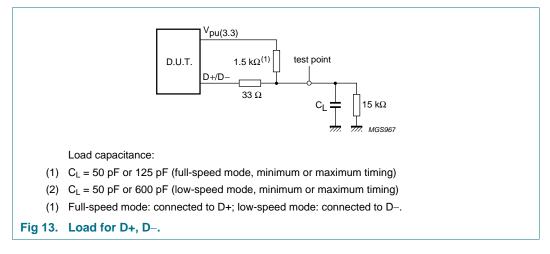


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## 13. Test information







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### 14. Package outline

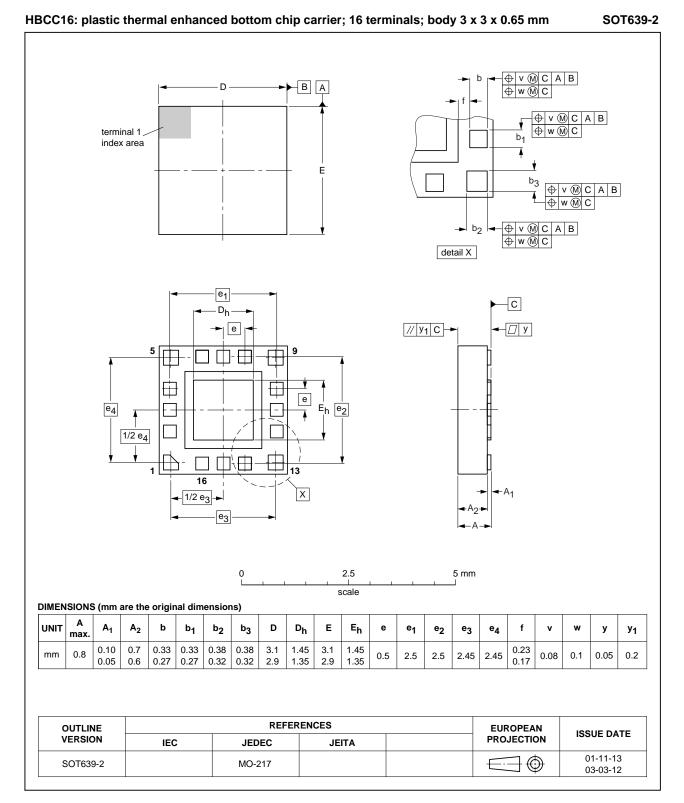
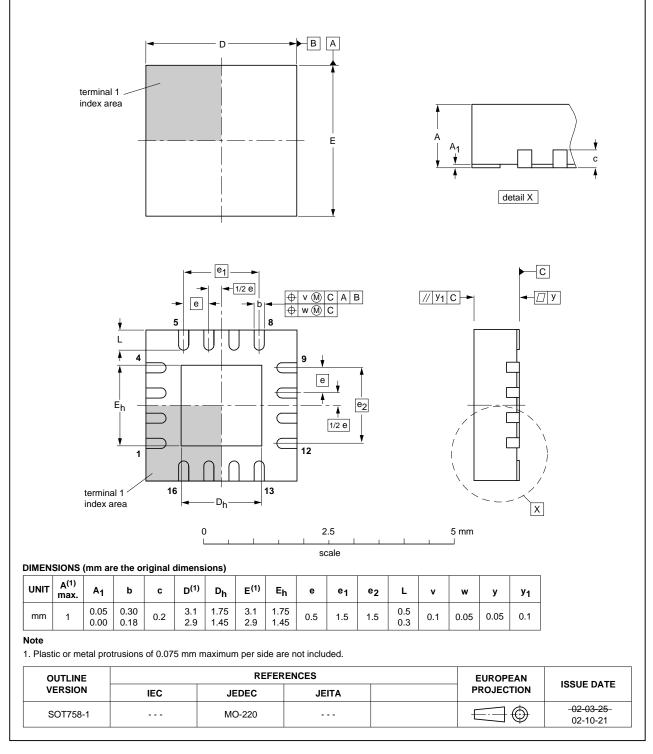


Fig 14. HBCC16 package outline.

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# HVQFN16: plastic thermal enhanced very thin quad flat package; no leads; 16 terminals; body 3 x 3 x 0.85 mm

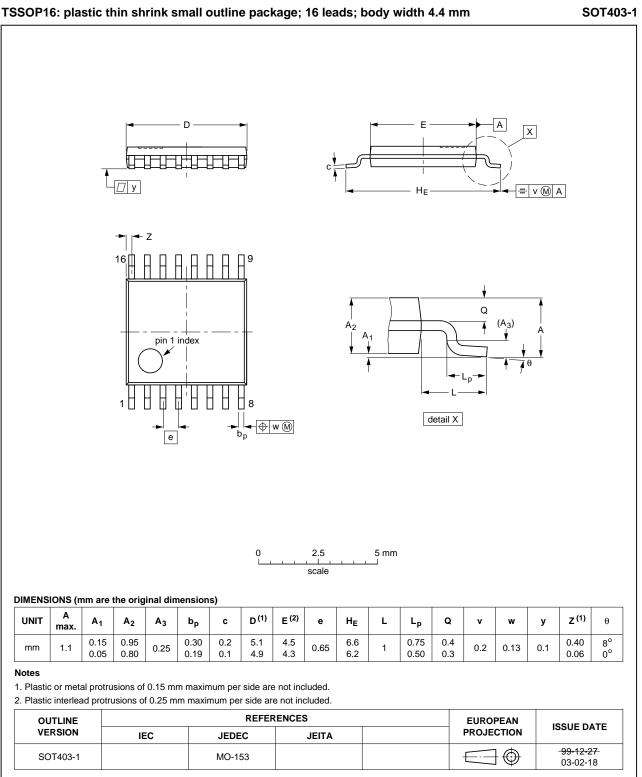
SOT758-1

#### Fig 15. HVQFN16 package outline.

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### TSSOP16: plastic thin shrink small outline package; 16 leads; body width 4.4 mm

Fig 16. TSSOP16 package outline.

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**Product data sheet** 



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## **15. Revision history**

#### Table 17. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
ISP1105_1106_10	20090928	Product data sheet	-	ISP1105_1106_9
Modifications:	<ul> <li>Rebrande</li> </ul>	d to the ST-Ericsson template.		
	Section 2	"Features": updated.		
	Section 4	"Ordering information": updated.		
	<ul> <li>Removed</li> </ul>	packing information.		
	<ul> <li>Removed</li> </ul>	soldering information.		
ISP1105_1106_9	20090119	Product data sheet	-	ISP1105_1106-08
ISP1105_1106-08 (9397 750 09529)	20040219	Product data	-	ISP1105_1106_1107-07
ISP1105_1106_1107-07 (9397 750 08872)	20020329	Product data	-	ISP1105_1106_1107-06
ISP1105_1106_1107-06 (9397 750 08681)	20011130	Product data	-	ISP1105_1106_1107-05
ISP1105_1106_1107-05 (9397 750 08643)	20010903	Product data	-	ISP1105_1106_1107-04
ISP1105_1106_1107-04 (9397 750 08515)	20010802	Preliminary data	-	ISP1105_1106_1107-03
ISP1105_1106_1107-03 (9397 750 07879)	20010704	Preliminary data	-	ISP1107-02
ISP1107-02 (9397 750 06899)	20010205	Objective specification; ISP1107 stand-alone data sheet only	-	ISP1107-01
ISP1107-01 (9397 750 08643)	20000223	Objective specification; ISP1107 stand-alone data sheet only		-



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